

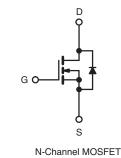
**Vishay Siliconix** 



### **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	900			
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	3.7		
Q <sub>g</sub> (Max.) (nC)	78			
Q <sub>gs</sub> (nC)	10			
Q <sub>gd</sub> (nC)	42			
Configuration	Single			





#### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole. It also provides greater creepage distances between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFPF30PbF
	SiHFPF30-E3
SnPb	IRFPF30
	SiHFPF30

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	900	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20	v	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	L_	3.6		
		T <sub>C</sub> = 100 °C	ID	2.3	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	14		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	170	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	3.6	A	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	PD	125	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	1.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 24 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 3.6$  A (see fig. 12).

c.  $I_{SD} \leq 3.6$  A, dI/dt  $\leq 70$  A/µs,  $V_{DD} \leq 600$ ,  $T_J \leq 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91249 S11-0442-Rev. B, 14-Mar-11 www.vishay.com



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0		

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 250 μA	900	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	Reference to 25 °C, I <sub>D</sub> = 1 mA		1.1	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
	I <sub>DSS</sub>	V <sub>DS</sub> = 90	V <sub>DS</sub> = 900 V, V <sub>GS</sub> = 0 V		-	100	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 720 V, V	/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2.2 A <sup>b</sup>	-	-	3.7	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 100 V, I <sub>D</sub> = 2.2 A <sup>b</sup>		2.3	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	1200	-	pF
Output Capacitance	C <sub>oss</sub>			-	320	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	200	-	
Total Gate Charge	Qg		$V_{GS} = 10 \text{ V}$ $I_D = 3.6 \text{ A}, V_{DS} = 360 \text{ V}$ see fig. 6 and 13 <sup>b</sup>	-	-	78	nC
Gate-Source Charge	$Q_gs$	$V_{GS} = 10 V$		-	-	10	
Gate-Drain Charge	Q <sub>gd</sub>			-	-	42	
Turn-On Delay Time	t <sub>d(on)</sub>			-	14	-	
Rise Time	t <sub>r</sub>	$V_{DD}=450 \text{ V}, \text{ I}_{D}=3.6 \text{ A},$ $\text{R}_{g}=12 \ \Omega, \text{ R}_{D}=120 \ \Omega, \text{ see fig. } 10^{\text{b}}$		-	25	-	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	90	-	
Fall Time	t <sub>f</sub>			-	30	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	24
Internal Source Inductance	L <sub>S</sub>			-	13	-	- nH
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.6	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	14	
Body Diode Voltage	$V_{SD}$	$T_J = 25 \ ^{\circ}C, \ I_S = 3.6 \ A, \ V_{GS} = 0 \ V^b$		-	-	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 3.6 A, dl/dt = 100 A/µs <sup>b</sup>		-	430	650	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.4	2.1	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$				 L)	

#### Notes

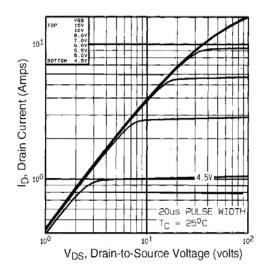
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

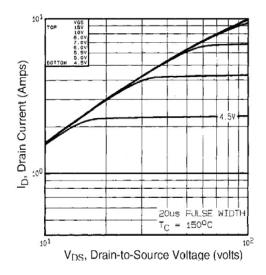
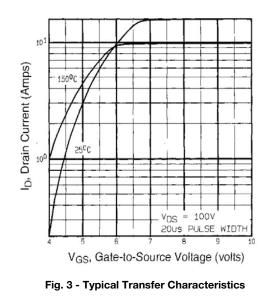


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150  $^\circ C$ 



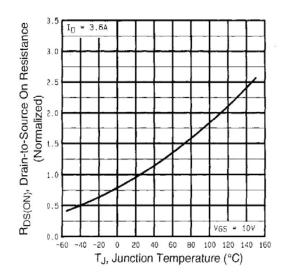


Fig. 4 - Normalized On-Resistance vs. Temperature

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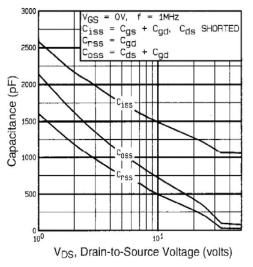


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

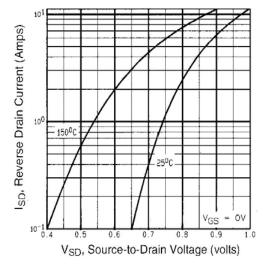


Fig. 7 - Typical Source-Drain Diode Forward Voltage

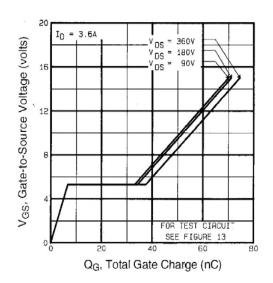


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

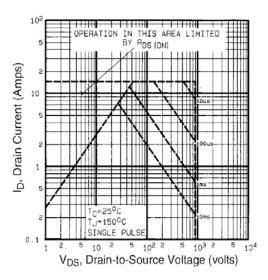


Fig. 8 - Maximum Safe Operating Area



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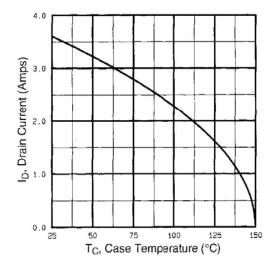


Fig. 9 - Maximum Drain Current vs. Case Temperature

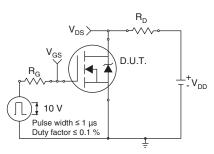


Fig. 10a - Switching Time Test Circuit

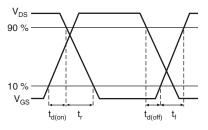


Fig. 10b - Switching Time Waveforms

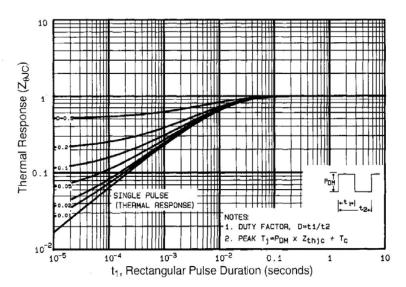


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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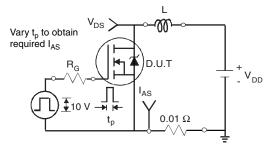


Fig. 12a - Unclamped Inductive Test Circuit

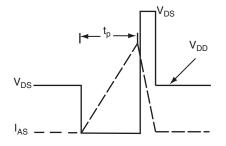


Fig. 12b - Unclamped Inductive Waveforms

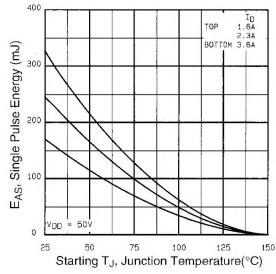


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

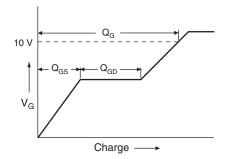


Fig. 13a - Basic Gate Charge Waveform

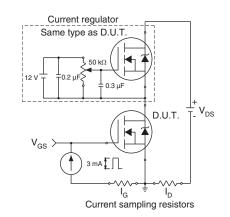
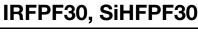


Fig. 13b - Gate Charge Test Circuit

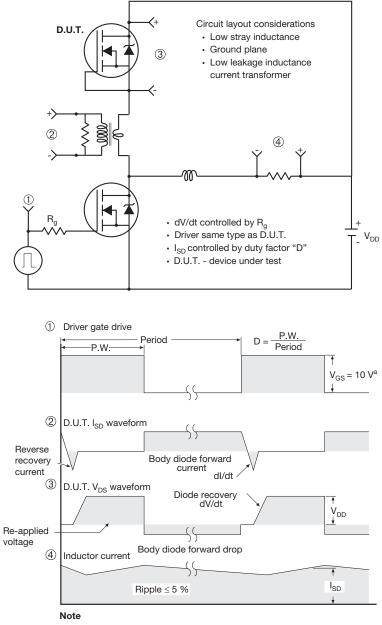
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS}$  = 5 V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?91249">www.vishay.com/ppg?91249</a>.

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<sup>7</sup> 

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### TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

#### Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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